

Overview

HP ProBook 430 G6 Notebook PC



Left

- | | |
|-----------------------------|--|
| 1. Internal microphones (2) | 6. SD Card reader |
| 2. Webcam | 7. Thermal vent |
| 3. Webcam LED | 8. USB 3.1 Gen 1 port |
| 4. Clickpad | 9. Security lock slot (Lock sold separately) |
| 5. Hard drive LED | 10. Power button |



Overview



Right

- | | |
|-----------------------------------|------------------------------------|
| 1. Power connector | 5. USB 3.1 Gen 1 port |
| 2. USB Type-C™ 3.1 Gen 1 port | 6. Headphone/microphone combo jack |
| 3. Ethernet port (RJ-45) | 7. HP Fingerprint Sensor |
| 4. HDMI port (Cable not included) | |

Overview

At a Glance

- Preinstalled with Windows 10 versions or FreeDOS 3.0
- Choice of 8th Generation Intel® Core™ i7, i5, i3 processors
- Display include your choice of 33.8 cm (13.3") diagonal HD, Ultra Wide Viewing Angle FHD, Touch or Non-Touch screen
- Integrated Intel® HD Graphics 610 and intel® UHD 620
- Enhanced security features including TPM2.0, HP BIOSphere, Hardware enforced Firmware Protection, optional Fingerprint sensor, and optional IR camera
- Designed to pass MIL-STD 810G testing.¹
- Weight starting at 3.28 lbs (1.49 kgs)
- HP Long-Life Rechargeable battery, with HP Fast Charge Technology recharges 50% in 30 minutes²
- Supports wireless LAN and wireless WWAN options for connectivity on the go
- Up to 512 GB Solid State Drives or 1 TB Hard Drive
- Up to 32 GB total system memory
- 720p HD webcam, IR camera for face authentication with Windows Hello
- Spill-resistant and optional backlit Keyboard, and Clickpad with multi-touch gestures enabled, taps enabled as default
- Enjoy the rich conferencing experience of the Skype for Business™ Certified HP ProBook 430

1. MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack.
2. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAMES

HP ProBook 430 G6 Notebook PC

OPERATING SYSTEMS

Preinstalled	Windows 10 Pro 64 ¹
	Windows 10 Pro 64 (National Academic only) ²
	Windows 10 Home 64 ¹
	Windows 10 Home Single Language 64 ¹
	Windows 10 China Government Edition
	FreeDOS 3.0

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see <https://aka.ms/ProEducation> for Windows 10 Pro Education feature information.

PROCESSORS

Intel® Core™ i7-8565U with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6}

Intel® Core™ i5-8265U with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores)^{3,4,5,6}

Intel® Core™ i3-8145U with Intel® UHD Graphics 620 (2.1 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 4 MB L3 cache, 2 cores)^{3,4,5,6}

Intel® Core™ i7+ 8565U processor (Core™ i7 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6,7}

Intel® Core™ i5+ 8265U processor (Core™ i5 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores)^{3,4,5,6,7}

Processors Family

8th Generation Intel® Core™ i7 processor (i7-8565U)⁶

8th Generation Intel® Core™ i5 processor (i5-8265U)⁶

8th Generation Intel® Core™ i3 processor (i3-8145U)⁶

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.
4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <http://www.intel.com/technology/turboboost> for more information.
6. NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.



Technical Specifications

7. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system and requires configuration with an optional Intel® Core™ i(5 or 7)+ processor.

CHIPSET

Integrated with processor

GRAPHICS

Integrated

Intel® UHD graphics 620⁸

8. HD content required to view HD images.

DISPLAYS

Internal

Non-Touch

33.8 cm (13.3") diagonal HD SVA eDP anti-glare LED-backlit Ultralim, 220 cd/m², 67% sRGB for two WLAN antennas (1366 x 768)^{8,10}

33.8 cm (13.3") diagonal HD SVA eDP anti-glare LED-backlit Ultralim, 220 cd/m², 67% sRGB for HD camera and two WLAN antennas (1366 x 768)^{8,10}

33.8 cm (13.3") diagonal HD SVA eDP anti-glare LED-backlit Ultralim, 220 cd/m², 67% sRGB for HD+IR camera and two WLAN antennas (1366 x 768)^{8,10}

33.8 cm (13.3") diagonal HD SVA eDP anti-glare LED-backlit Ultralim, 220 cd/m², 67% sRGB for HD camera, WWAN and two WLAN antennas (1366 x 768)^{8,10}

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD camera and two WLAN antennas (1920 x 1080)^{8,10}

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD+IR camera and two WLAN antennas (1920 x 1080)^{8,10}

33.8 cm (13.3") diagonal FHD UWVA eDP anti-glare LED-backlit slim, 220 cd/m², 67% sRGB for HD camera, WWAN and two WLAN antennas (1920 x 1080)^{8,10}

Touch

33.8 cm (13.3") diagonal HD SVA eDP LED-backlit Ultralim touch screen, 220 cd/m², 67% sRGB for HD camera and two WLAN antennas (1366 x 768)^{8,9,10}

33.8 cm (13.3") diagonal FHD UWVA eDP LED-backlit slim touch screen, 220 cd/m², 67% sRGB for HD camera and two WLAN antennas (1920 x 1080)^{8,9,10}

33.8 cm (13.3") diagonal FHD UWVA eDP LED-backlit slim touch screen, 220 cd/m², 67% sRGB for HD camera, WWAN and two WLAN antennas (1920 x 1080)^{8,9,10}

HDMI

Supports resolutions up to 4K 30Hz

8. HD content required to view HD images.

9. Sold separately or as an optional feature.

10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.



Technical Specifications

Docking station model	Total number of supported displays (incl. the notebook display)	Max. resolutions supported	Dock Connectors	Technical limitations
HP Thunderbolt Dock 120W G2	3	Dual 4k @60Hz	2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode	Dual 4k only with one display in to DP and + TB port or USB-C alt mode + TB port
HP USB-C Dock G4	3	Dual 2K @ 60Hz Single 4K @ 60Hz (3840 x 1440)	1xHDMI, 2xDP	
HP USB-C Universal Dock	3	Dual 4K @ 60Hz Single 5K @ 60Hz	2xDP	
HP USB-C Travel Dock	2	Single 2K @ 60Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time
HP USB-C Mini Dock	2	Single 4K @ 30Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time

STORAGE AND DRIVES

Primary Storage500 GB 7200 rpm SATA¹¹1 TB 5400 rpm SATA¹¹**Primary M.2 Storage**128 GB M.2 SATA TLC Solid State Drive¹¹256 GB PCIe® NVMe™ M.2 Value Solid State Drive¹¹512 GB PCIe® NVMe™ M.2 TLC Solid State Drive¹¹

11. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

NOTE: PCIe SSD not available for Celeron

MEMORY

Memory32 GB DDR4-2400 SDRAM (2 x 16 GB)¹²

16 GB DDR4-2400 SDRAM (1 x 16 GB)

16 GB DDR4-2400 SDRAM (2 x 8 GB)¹²12 GB DDR4- 2400 SDRAM (4 GB and 8 GB (1 x 8 GB)¹²

8 GB DDR4-2400 SDRAM (1 x 8 GB)

8 GB DDR4-2400 SDRAM (2 x 4 GB)¹²

4 GB DDR4-2400 SDRAM (1 x 4 GB)



Technical Specifications

Maximum

32 GB DDR4-2400 SDRAM¹²

Memory Slots

2 SODIMM

Both slots are customer accessible / upgradeable

DDR4 PC4 SODIMMS, system runs at 2400

Supports Dual Channel Memory

12. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Wireless LAN (WLAN)

Realtek 802.11ac (2x2) WLAN and Bluetooth® 4.2 Combo¹³

Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) WLAN and Bluetooth® 5 Combo, non-vPro™¹³

Broadband Wireless (WWAN)

Intel® XMM™ 7262 LTE-Advanced (Cat6)¹⁴

Intel® XMM™ 7360 LTE-Advanced (Cat9)¹⁴

Ethernet

Realtek RTL8111HSH-CG 10/100/1000 GbE NIC¹⁵

13. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.
14. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.
15. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

Integrated microphone (Mono or Dual Array)

2 Integrated stereo speakers

Camera

720p HD camera⁸

720p HD camera+IR Camera^{8,9}

8. HD content required to view HD images.
9. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS



Not all configuration components are available in all regions/countries.
c06142919 — DA 16310 - Worldwide — Version 05 — December 21, 2018

Technical Specifications

Keyboard

HP Premium Keyboard, spill resistant with optional backlit function

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

ESC: system information

F1 - Display Switching

F2 - Blank

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - numlk

F11 - Wireless

F12 - Sleep

Hidden Functions

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

Fn+E - Insert

SOFTWARE AND SECURITY

BIOS

HP BIOSphere Gen4¹⁶

HP DriveLock & Automatic DriveLock

BIOS Update via Network

Secure Erase¹⁷

Absolute Persistence Module¹⁸

Pre-boot Authentication

HP Wireless Wakeup

Software

HP Native Miracast Support¹⁹

HP LAN-Wireless Protection

HP Connection Optimizer

HP 3D DriveGuard

HP Hotkey Support - CMIT

HP Jumpstart

HP Support Assistant²⁰

HP Noise Cancellation Software

HP Host Based MAC Address Manager



Technical Specifications

Buy Office (sold separately)

Manageability Features

HP Driver Packs²¹

HP System Software Manager (SSM)

HP BIOS Config Utility (BCU)

HP Client Catalog

HP Manageability Integration Kit Gen2²²

Ivanti Management Suite²³

Client Security Software

- HP Client Security Suite Gen4²⁴ including:

- HP Security Manager²⁵ (including Credential Manager, HP Password Manager, HP Spare Key)

- HP Fingerprint Sensor²⁶

- HP Device Access Manager²⁷

- HP Power On Authentication

Windows Defender²⁸

Security Management

Secure Erase¹⁷

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)²⁹

SATA 0,1 port disablement (viaBIOS)

RAID configurations³⁰

Serial, USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Setup password (viaBIOS)

Support for chassis padlocks and cable lock devices

Integrated hood sensor

HP Sure Click³¹

16. HP BIOSphere Gen4 requires Intel(R) or AMD 8th Gen processors. Features may vary depending on the platform and configurations.
17. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method.
18. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: <http://www.absolute.com/company/legal/agreements/computrace-agreement>. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
19. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming
20. HP Support Assistant requires Windows and Internet access.



Technical Specifications

21. HP Driver Packs not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>.
22. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>
23. Ivanti Management Suite subscription required
24. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.
25. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.
26. HP Fingerprint Sensor sold separately or as an optional feature.
27. HP Device Access Manager requires HP Client Security Suite Gen4.
28. Windows Defender Opt in and internet connection required for updates.
29. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).
30. RAID configuration is optional and does require a second hard drive.
31. HP Sure Click is available on most HP PCs and supports Microsoft® Internet Explorer and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.

POWER

HP Smart 65 W External AC power adapter³²
 HP Smart 65 W EM External AC power adapter³²
 HP Smart 65 W USB Type-C™ adapter³²
 HP Smart 45 W External AC power adapter³²
 HP Smart 45 W USB Type-C™ adapter³²

Primary Battery

HP Long Life 3-cell, 45 Wh Li-ion³³

Power Cord

3-wire plug - 1m³²
 3-wire plug - 1.8m³²
 2-wire plug - 1m³²
 Duckhead power cord- 1m³²
 Duckhead power cord- 1.8m³²

Battery Life

Up to 14 hours³⁴

Battery Weight

0.49 lb
 0.22 kg

32. Availability may vary by country.

33. Battery is internal and not replaceable by customer. Serviceable by warranty.

34. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <http://www.bapco.com> for additional details.



Technical Specifications

WEIGHTS & DIMENSIONS

Weight

Starting at 3.28 lb³⁵

Starting at 1.49 kg³⁵

Dimensions (w x d x h)

12.15 x 9.09 x 0.71 in

30.85 x 23.1 x 1.8 cm

35. Weight will vary by configuration.

PORTS/SLOTS

Ports

1 USB 3.1 Type-C™ Gen 1 (Power delivery, DisplayPort™)

1 USB 3.1 Gen 1

1 USB 3.1 (Powered port)

1 HDMI 1.4b³⁶

1 RJ-45

1 AC power

1 Headphone/microphone combo jack

Expansion Slots

1 SD

Supports SD, SDHC, SDXC

36. HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers 3-year and 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life Batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>.³⁷

37. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit <http://www.hp.com/go/cpc>. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications

ENVIRONMENTAL & INDUSTRY

HP PROBOOK 430 G6 NOTEBOOK PC

Eco-Label Certifications & declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: <ul style="list-style-type: none">•IT ECO declaration•US ENERGY STAR®•EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country.•TCO or TCO Certified Edge		
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a Typically Configured Notebook.		
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	5.17 W	5.30 W	5.14 W
Normal Operation (Long idle)	2.84 W	2.79 W	2.77 W
Sleep	0.61 W	0.64 W	0.61 W
Off	0.38 W	0.42 W	0.38 W
	Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.		
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation (Short idle)	18 BTU/hr	18 BTU/hr	18 BTU/hr
Normal Operation (Long idle)	10 BTU/hr	10 BTU/hr	9 BTU/hr
Sleep	2 BTU/hr	2 BTU/hr	2 BTU/hr
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr
	Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.		
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)	
Typically Configured – Idle	2.7	24.2	
Fixed Disk – Random writes	2.8	25.1	
Longevity and Upgrading	This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include: <ul style="list-style-type: none">• 3 USB ports• 1 PC card slot (type I/II)• 1 ExpressCard/54 slot• 1 IEEE 1394 Port• 2 SODIMM memory slots• Optional expansion base docking station• 1 multi-bay II storage port• Interchangeable HDD		



Technical Specifications

	Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.		
Batteries	<p>This battery(s) in this product comply with EU Directive 2006/66/EC</p> <p>Batteries used in the product do not contain:</p> <p>Mercury greater the 1ppm by weight</p> <p>Cadmium greater than 20ppm by weight</p> <p>Battery size: CR2032 (coin cell)</p> <p>Battery type: lithium/manganese dioxide</p>		
Additional Information	<ul style="list-style-type: none"> • This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. • This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. • This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). • This product is in compliance with the IEEE 1680 (EPEAT) standard at the <gold> level in the U.S. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options • Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. • This product contains 0% post-consumer recycled plastic (by wt.) • This product is 95.1% recycle-able when properly disposed of at end of life. 		
Packaging Materials	External:	PAPER/Corrugated	281 g
	Internal:	PLASTIC/Polyethylene Expanded - EPE	62 g
		PLASTIC/Polyethylene low density – LDPE	9 g
Material Usage	<p>This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):</p> <ul style="list-style-type: none"> • Asbestos • Certain Azo Colorants • Certain Brominated Flame Retardants – may not be used as flame retardants in plastics • Cadmium • Chlorinated Hydrocarbons • Chlorinated Paraffins • Formaldehyde • Halogenated Diphenyl Methanes • Lead carbonates and sulfates • Lead and Lead compounds • Mercuric Oxide Batteries • Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. • Ozone Depleting Substances • Polybrominated Biphenyls (PBBs) • Polybrominated Biphenyl Ethers (PBBEs) • Polybrominated Biphenyl Oxides (PBBOs) • Polychlorinated Biphenyl (PCB) • Polychlorinated Terphenyls (PCT) • Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. • Radioactive Substances • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) 		



Technical Specifications

Packaging Usage	<p>HP follows these guidelines to decrease the environmental impact of product packaging:</p> <ul style="list-style-type: none"> • Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. • Eliminate the use of ozone-depleting substances (ODS) in packaging materials. • Design packaging materials for ease of disassembly. • Maximize the use of post-consumer recycled content materials in packaging materials. • Use readily recyclable packaging materials such as paper and corrugated materials. • Reduce size and weight of packages to improve transportation fuel efficiency. • Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	<p>HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.</p> <p>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.</p>
HP Inc. Corporate Environmental Information	<p>For more information about HP's commitment to the environment:</p> <p>Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</p>

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage	19V
Average Operating Power	Win 10
Integrated graphics	5.71W
Max Operating Power	UMA < 45W

Temperature

Operating	32° to 95° F (0° to 35° C)
Non-operating	-4° to 140° F (-20° to 60° C)

Relative Humidity

Operating	10% to 90%, non-condensing
Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock



Technical Specifications

Operating	40 G, 2 ms, half-sine
Non-operating	200 G, 2 ms, half-sine
Random Vibration	
Operating	0.75 grms
Non-operating	1.50 grms
Altitude (unpressurized)	
Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Planned Industry Standard Certifications	
UL	Yes
CSA	Yes
FCC Compliance	Yes
ENERGY STAR®	Selected models ³⁸
EPEAT	Registered Gold in United States ³⁹
ICES	Yes
Australia /	Yes
NZ A-Tick Compliance	Yes
CCC	Yes
Japan VCCI Compliance	Yes
KC	Yes
BSMI	Yes
CE Marking Compliance	Yes
BNCI or BELUS	Yes
CIT	Yes
GOST	Yes
Saudi Arabian Compliance (ICCP)	Yes
SABS	Yes
UKRSERTCOMPUTER	Yes

38. Configurations of the HP ProBook 430 G6 that are ENERGY STAR® certified² are identified as HP ProBook 430 G6 ENERGY STAR on HP websites and on <http://www.energystar.gov>.

39. EPEAT® registered where applicable. EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at <http://www.hp.com/go/options>.

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

**Panel LCD 13.3 inch
diagonal FHD (1920x1080)**

Outline Dimensions (W x H x D)

300.56 x 187.77 max.

Active Area

293.76 x 165.24 typ.



Not all configuration components are available in all regions/countries.
c06142919 — DA 16310 - Worldwide — Version 05 — December 21, 2018

Technical Specifications

Anti-Glare WLED UWVA 45% cg 220nits eDP slim NB non-touch	Weight	<260 max.
	Diagonal Size	13.3"
	Thickness	3.0mm max.
	Interface	eDP 1.2 (2 lanes)
	Surface Treatment	Anti-glare
	Touch Enabled	No
	Contrast Ratio	600:1 (typ)
	Refresh Rate	60Hz
	Brightness	220 nits typical (Panel Only)
	Pixel Resolution	1920 x 1080 (FHD)
	Format	RGB
	Backlight	LED
	Color Gamut Coverage	45%
	Color Depth	6 bits (Hi FRC @ system GFX output 8bits)
	Viewing Angle	UWVA 85/85/85/85

Panel LCD 13.3 inch diagonal FHD (1920x1080) WLED UWVA 45% cg 220nits eDP slim NB touch	Outline Dimensions (W x H x D)	300.56 x 187.77 max.
	Active Area	293.76 x 165.24 typ.
	Weight	<383 max.
	Diagonal Size	13.3"
	Thickness	3.2mm max.
	Interface	eDP 1.2 (2 lanes)
	Surface Treatment	BrightView Glass
	Touch Enabled	Yes
	Contrast Ratio	600:1 (typ)
	Refresh Rate	60Hz
	Brightness	220 nits typical (Panel Only)
	Pixel Resolution	1920 x 1080 (FHD)
	Format	RGB
	Backlight	LED
	Color Gamut Coverage	45%
	Color Depth	6 bits (Hi FRC @ system GFX output 8bits)
	Viewing Angle	UWVA 85/85/85/85

Panel LCD 13.3 inch diagonal HD (1366x768) Anti-Glare WLED SVA 45% cg 220nits eDP slim NB non-touch	Outline Dimensions (W x H x D)	300.56 x 187.77 max. (w/ PCB & w/o bracket)
	Active Area	293.83 x 165.20 typ.
	Weight	<260 max.
	Diagonal Size	13.3 (inch)
	Thickness	3.0mm max.
	Interface	eDP 1.2 (2 lanes)
	Surface Treatment	Anti-glare
	Touch Enabled	No



Technical Specifications

Panel LCD 13.3 inch diagonal HD (1366x768) WLED SVA 45% cg 220nits eDP slim NB touch	Contrast Ratio	300:1 (typ)
	Refresh Rate	60Hz
	Brightness	220 nits typical (Panel Only)
	Pixel Resolution	1366 x 768 (HD)
	Format	RGB
	Backlight	LED
	Color Gamut Coverage	45%
	Color Depth	6 bits (Hi FRC @ system GFX output 8bits)
	Viewing Angle	SVA 45/45/15/30
	Outline Dimensions (W x H x D)	300.56 x 187.77 max. (w/ PCB & w/o bracket)
Panel LCD 13.3 inch diagonal HD (1366x768) WLED SVA 45% cg 220nits eDP slim NB touch	Active Area	293.83 x 165.20 typ.
	Weight	<383 max.
	Diagonal Size	13.3 (inch)
	Thickness	3.2mm max.
	Interface	eDP 1.2 (2 lanes)
	Surface Treatment	BrightView Glass
	Touch Enabled	Yes
	Contrast Ratio	300:1 (typ)
	Refresh Rate	60Hz
	Brightness	220 nits typical (Panel Only)
	Pixel Resolution	1366 x 768 (HD)
	Format	RGB
	Backlight	LED
	Color Gamut Coverage	45%
	Color Depth	6 bits (Hi FRC @ system GFX output 8bits)
	Viewing Angle	SVA 45/45/15/30

STORAGE AND DRIVES

Hard Drives

500 GB 7200 rpm SATA Hard Drive	Drive Weight	0.20 lbs (92 g) ~ 0.21 lbs (95 g)
	Rotation speed	7200 rpm
	Cache Buffer	Up to 32 MB
	Height	0.28 in (7 mm)
	Width	2.75 in (69.85 mm)
	Interface	ATA-8, SATA 3.0
	Transfer Rate	600 MB/s
	Seek Time	Single Track: 2 ~ 1.5 ms; Average: 11 ~ 13 ms; Maximum: 18 ~ 22 ms
	Logical Blocks	976,773,168
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
500 GB 7200 rpm SATA Hard Drive	Security Features	ATA Security



Technical Specifications

	Features	S.M.A.R.T., NCQ, Ultra DMA
1 TB 5400 rpm SATA Hard Drive	Drive Weight	0.21 lbs (94 g)
	Rotation speed	5400 rpm
	Cache Buffer	Up to 32 MB
	Height	0.28 in (7.2 mm)
	Width	2.75 in (69.85 mm)
	Interface	ATA-8, SATA 3.0
	Transfer Rate	600 MB/s
	Seek Time	Single Track2 ms
		Average12 ~ 13 ms
		Maximum18 ~ 22 ms
	Logical Blocks	1,953,525,168
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
	Security Features	ATA Security
	Features	S.M.A.R.T., NCQ, Ultra DMA

Technical Specifications

SSD 128 GB 2280 M2 SATA-3 TLC	Form Factor	M.2 2280
	Capacity	128GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	ATA-8, SATA 3.0
	Maximum Sequential Read	Up To 520 MB/s
	Maximum Sequential Write	Up To 450 MB/s
	Logical Blocks	250,069,680
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	DIPM; TRIM; DEVSLP

256 GB 2280 PCIe NVMe Value Solid State Drive	Form Factor	M.2 2280
	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	Up To 1700 MB/s
	Maximum Sequential Write	Up to 1300 MB/s
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TRIM; L1.2

512 GB 2280 M2 PCIe NVMe TLC Solid State Drive	Form Factor	M.2 2280
	Capacity	512 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	Up To 2600 MB/s
	Maximum Sequential Write	Up To 1400 MB/s
	Logical Blocks	1,000,215,216
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TRIM; L1.2



Technical Specifications

16 GB 2280 PCIe-3x2 NVMe 3D Xpoint Solid State Drive	Form Factor	M.2 2280
	Capacity	16 GB
	NAND Type	Xpoint
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3X2
	Maximum Sequential Read	1400
	Maximum Sequential Write	300
	Logical Blocks	28,181,188
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	L1.2

NETWORKING/COMMUNICATIONS

WWAN

Intel® XMM™ 7262 LTE-Advanced DL CAT6¹	Technology/Operating bands	FDD LTE: 2100 (Band 1), 1800 (Band 3), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 800 (Band 20), 700 (Band 28), HSPA+: 2100 (Band 1), 850 (Band 5), 900 (Band 8)
	Wireless protocol standards	3GPP Release 11 LTE Specification CAT.6, DL 40MHz BW throughput up to 300Mbps; UL 20MHz throughput up to 50Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone, A-GPS (MS-A, MS-B and XTRA)
	GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
	Maximum data rates	LTE: 300 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm
	Maximum power consumption	LTE: 1,200 mA (peak); 830 mA (average) HSPA+: 1,100 mA (peak); 680 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6 g
	Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm

1. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

Intel® XMM™ 7360 LTE-Advanced CAT9¹	Technology/Operating bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850



Technical Specifications

	(Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66).
	TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41).
	HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
Wireless protocol standards	3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to 450Mbps; UL 20MHz throughput up to 50Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS	Standalone, A-GPS (MS-A, MS-B)
GPS bands	1575.42 MHz \pm 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
Maximum data rates	LTE: 450 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm
Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	5.8 g
Dimensions (Length x Width x Thickness)	42 30 x 2.3 mm

1. WWAN module is optional, must be configured at the factory and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

WLAN

Intel® 9560
802.11a/b/g/n/ac (2x2)
WLAN and Bluetooth® 5.0
Combo¹
non-vPro

Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
Interoperability	Wi-Fi® certified
Frequency Band	802.11b/g/n • 2.402 – 2.482 GHz 802.11a/n/ac • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz



Technical Specifications

Data Rates	<ul style="list-style-type: none"> • 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) • 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, , 80MHz & 160MHz)
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security³	<ul style="list-style-type: none"> • IEEE and WiFi® compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • IEEE 802.11i • Cisco Certified Extensions, all versions through CCX4 and CCX Lite • WAPI
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power²	<ul style="list-style-type: none"> • 802.11b : +18.5dBm minimum • 802.11g : +17.5dBm minimum • 802.11a : +18.5dBm minimum • 802.11n HT20(2.4GHz) : +15.5dBm minimum • 802.11n HT40(2.4GHz) : +14.5dBm minimum • 802.11n HT20(5GHz) : +15.5dBm minimum • 802.11n HT40(5GHz) : +14.5dBm minimum • 802.11ac VHT80(5GHz) : +11.5dBm minimum • 802.11ac VHT160(5GHz) : +11.5dBm minimum
Power Consumption	Transmit mode: 2.0 W Receive mode: 1.6 W Idle mode (PSP)180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connected Standby/Modern Standby: 10mW Radio disabled: 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity³	802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications



Technical Specifications

Form Factor	PCI-Express M.2 MiniCard with CNVi Interface	
Dimensions	1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm	
Weight	1. Type 2230: 2.8g 2. Type 1216: 1.3g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating	14° to 158° F (–10° to 70° C)
	Non-operating	–40° to 176° F (–40° to 80° C)
Humidity	Operating	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON	
1. Check latest software/driver release for updates on supported security features.		
2. Maximum output power may vary by country according to local regulations.		
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).		
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology		
Bluetooth® Specification	4.0/4.1/4.2/5.0 Compliant	
Frequency Band	2402 to 2480 MHz	
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)	
Signaling Data Rate	Legacy: 3 Mbps signaling rate ¹ BLE: 1 Mbps signaling data rate ¹ 1. Actual throughput may vary.	
	Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels	
	Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)	
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.	
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW	
Electrical Interface	USB 2.0 compliant	
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software	
Power Management Certifications	Microsoft Windows ACPI, and USB Bus Support FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950UL, CSA, and CE Mark	
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping	

Not all configuration components are available in all regions/countries.
c06142919 — DA 16310 - Worldwide — Version 05 — December 21, 2018



Technical Specifications

LE Dual Mode
 LE Link Layer
 LE Low Duty Cycle Directed Advertising
 LE L2CAP Connection Oriented Channels
 Train Nudging & Interlaced Scan
 BT4.2 ESR08 Compliance
 LE Secure Connection- Basic/Full
 LE Privacy 1.2 –Link Layer Privacy
 LE Privacy 1.2 –Extended Scanner Filter Policies
 LE Data Packet Length Extension
 FAX Profile (FAX)
 Basic Imaging Profile (BIP)2
 Headset Profile (HSP)
 Hands Free Profile (HFP)
 Advanced Audio Distribution Profile (A2DP)

Realtek
802.11a/b/g/n/ac (2x2)
WLAN and Bluetooth® 4.1
Combo¹

Wireless LAN Standards

IEEE 802.11a
 IEEE 802.11b
 IEEE 802.11g
 IEEE 802.11n
 IEEE 802.11ac

Interoperability

Wi-Fi® certified

Frequency Band

802.11b/g/n
 • 2.402 – 2.482 GHz

802.11a/n
 • 4.9 – 4.95 GHz (Japan)
 • 5.15 – 5.25 GHz
 • 5.25 – 5.35 GHz
 • 5.47 – 5.725 GHz
 • 5.825 – 5.850 GHz

Data Rates

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)

Modulation

Direct Sequence Spread Spectrum
 BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³

- IEEE and Wi-Fi® compliant 64 / 128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- Cisco Certified Extensions, all versions through CCX4 and CCX Lite
- WAPI

Network Architecture

Ad-hoc (Peer to Peer)



Technical Specifications

Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power²	<ul style="list-style-type: none"> 802.11b: +14dBm minimum 802.11g: +12dBm minimum 802.11a: +12dBm minimum 802.11n HT20(2.4GHz): +12dBm minimum 802.11n HT40(2.4GHz): +12dBm minimum 802.11n HT20(5GHz): +10dBm minimum 802.11n HT40(5GHz): +10dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum
Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10 mW (WLAN+BT) Radio disabled: 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity³	802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230: 2.3 x 22.0 x 30.0 mm
Weight	Type 2230: 2.8g
Operating Voltage	3.3v +/- 9%
Temperature	Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)
Humidity	Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)
Altitude	Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – Radio ON
<ol style="list-style-type: none"> 1. Check latest software/driver release for updates on supported security features. 2. Maximum output power may vary by country according to local regulations. 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation). 	

HP Integrated Module with Bluetooth 4.0/4.1 Wireless Technology

Bluetooth® Specification 4.0/4.1 Compliant



Technical Specifications

Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Signaling Data Rate	Legacy: 3 Mbps signaling data rate ¹ BLE: 1 Mbps signaling data rate ¹ Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels 1. Actual throughput may vary. Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW
Electrical Interface	USB 2.0 compliant
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)



Technical Specifications

POWER

HP 45W Smart AC Adapter	Dimensions (H x W x D)	3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)
	Weight	0.386 lb (175g) max
	Input	90 to 265 VAC
		Input Efficiency87.74% at 115Vac and 88.4% at 230Vac
		Input frequency range47 to 63 Hz
		Input AC current1.4 A at 90 VAC
	Output	Output power45W
		DC output19.5V
		Hold-up time5 msec at 115 VAC input
		Output current limit<8.0A
	Connector	4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords
	Environmental Design	Operating temperature32°F to 95°F (0° to 35°C)
		Non-operating (storage) temperature-4°F to 185°F (-20° to 85°C)
		Altitude0 to 16,400 ft (0 to 5,000 m)
		Humidity20% to 95%
		Storage Humidity10% to 95%
	EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Smart AC Adapter	Dimensions	90x51x28.5mm
	Weight	unit: 220g +/- 10g
		Input Efficiency88% at 115 VAC and 89% at 230 VAC
		Input frequency range47 to 63 Hz
		Input AC current1.7 A at 90 VAC
	Output	Output power65W
		DC output19.5V
		Hold-up time5 ms at 115 VAC input
		Output current limit<11A
	Connector	4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords
	Environmental Design	Operating temperature32°F to 95°F (0°to 35°C)
		Non-operating (storage) temperature-4°F to 185°F (-20°to 85°C)
		Altitude0 to 16,400 ft (0 to 5000m)

Technical Specifications

EMI and Safety Certifications	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	CE Mark - full compliance with LVD and EMC directives* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.	

HP 65W EM Smart AC adapter	Dimensions	102x55x30mm		
	Weight	270g +/- 10g		
	Input Efficiency	87% min at 115V/230V		
	Input frequency range	47 to 63 Hz		
	Input AC current	1.7 A at 90 VAC and maximum load		
	DC output	65W(19.5V/3.33A)		
	Hold-up time	5 msec at 115 VAC input		
	Output current limit	<11A, Over voltage protection- 29V max automatic shutdown		
	Connector	4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords		
	Environmental Design	Operating temperature	0° to 35° C	
		Non-operating (storage) temperature	-20° to 85° C	
		Altitude	0 to 5,000 m	
		Humidity	0% to 95%	
		Storage Humidity	0% to 95%	
	EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.		

AC Adapter 65 Watt nPFC USB type C	Dimensions	74x74x28.5mm
	Weight	unit: 245g +/- 10g
	Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A
		86.7% min at 115 Vac/ 230Vac @ 9V/3A
		88% min at 115 Vac/ 230Vac @ 10V/5A
		88% min at 115 Vac/ 230Vac @ 12V/5A
		89% min at 115 Vac/ 230Vac @ 15V/4.33A
		89% min at 115 Vac/ 230Vac @ 20V/3.25A
	Input frequency range	47 ~ 63 Hz
	Input AC current	1.7 A at 90 VAC and maximum load
	Output power	65W



Technical Specifications

Connector	DC output	5V/9V/10V/12V/15V/20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<8.0A
Environmental Design	Type C	
	Operating temperature	32°F to 95°F (0° to 35°C)
	Non-operating (storage) temperature	-4°F to 185°F (-20° to 85°C)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	5% to 95%
EMI and Safety Certifications	Storage Humidity	5% to 95%
	CE Mark - full compliance with LVD and EMC directives* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.	

AC Adapter 45 Watt nPFC USB type C	Dimensions	62.0x62.0x28.5mm
	Weight	unit: 220g +/- 10g
Connector	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec:5V : 81.5%9V : 86.7%10V : 87.5%12V : 87.8%15V : 87.8%20V : 87.8%
	Input frequency range	47 ~ 63Hz
	Input AC current	Max. 1.4 A at 90 Vac
	Output power	5V/15W 9V/27W 10V/37.5W 12V/45W 15V/45W 20V/45W
	DC output	5V / 9V / 10V / 12V / 15V / 20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<5.0A
	Type C	
	Operating temperature	32°F to 95°F (0° to 35°C)
	Non-operating (storage) temperature	-4°F to 185°F (-20° to 85°C)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	Environmental Design	



Technical Specifications

EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.
-------------------------------	--

3 Cell WHr 45 Long Life - Polymer HP Fast Charge Technology ¹	Dimensions	6.0. x184.7x88.9 mm
	Weight	0.22 kg (0.48lb)
	Cells/Type	3cell Lithium-Ion
	Voltage	11.55V
	Amp-hour capacity	3.900Ah
	Watt-hour capacity	45Wh
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C)

1. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.

Country of Origin
China



Options and Accessories (sold separately and availability may vary by country)

Type	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA
	HP Essential Backpack	H1D24AA
	HP Essential Messenger Case	H1D25AA
Docking	HP USB-C Mini Dock	1PM64AA
	HP USB-C Universal Dock	1MK33AA
	HP USB-C Dock G4	3FF69AA
Input/Output	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP HDMI to DVI Adapter	F5A28AA
Memory	4GB 2666MHz DDR4	4VN05AA
	8GB 2666MHz DDR4	4VN06AA
	16GB 2666 MHz DDR4	4VN07AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 65W USB-C Power Adapter	3PN48AA
	HP 45W USB-C Power Adapter	1HE17AA
	HP 65W USB-C Power Adapter	1HE08AA
	HP Power Bank	N9F71AA
	HP USB-C Power Bank	2NA10AA
Storage	HP 45W LC USB-C Power Adapter	1MZ01AA#ABA
	HP External USB Optical Drive	F2B56AA
	HP 500GB 7200rpm HDD	F3B97AA
Security	HP Combination Lock	T0Y15AA
	HP Essential Keyed Cable lock 12.3mm	T0Y14AA
	HP Keyed Cable Lock 10mm	T1A62AA
	HP UltraSlim Keyed Cable Lock	T1A62AA
UCC	HP Conferencing Keyboard	K8P74AA
	HP Speaker Phone	K7V16AA
	HP Wired Headset	K7V17AA
Displays	HP ProDisplay P223 21.5-inch Monitor	X7R61AA
	HP ProDisplay P232 23-inch Monitor	K7X31AA
	HP ProDisplay P240va 23.8-inch Monitor	X3B48AA
	HP EliteDisplay E243 23.8-inch Monitor	1FH47AA
	HP EliteDisplay E243m 23.8-inch Collaboration Monitor	1FH48AA
	HP EliteDisplay E273 27-inch Monitor	1FH50AA



Summary of Changes

Date of change:	Version History:		Description of change:
December 10, 2018	V1 to V2	Removed	Dock UltraSlim
December 12, 2018	V2 to V3	Removed	Phonewise Software
December 17, 2018	V3 to V4	Added	Environmental section
December 21, 2018	V4 to V5	Added	Skype in at a glance section

Copyright © 2018 HP Development Company, L.P. The only warranties for HP products are set forth in the express limited warranty statements accompanying such products. Nothing herein should be construed as constituting an additional warranty. HP shall not be liable for technical or editorial errors or omissions contained herein.

Bluetooth is a trademark of its proprietor and used by HP Inc. under license. Intel, Core, Celeron and Intel vPro are trademarks of Intel Corporation or its subsidiaries in the U.S. and/or other countries. NVIDIA, the NVIDIA logo, and GeForce are trademarks and/or registered trademarks of NVIDIA Corporation in the U.S. and other countries. USB Type-C™ and USB-C™ are trademarks of USB Implementers Forum. ENERGY STAR is a registered trademark of the U.S. Environmental Protection Agency. Microsoft and Windows are either registered trademarks or trademarks of Microsoft Corporation in the United States and/or other countries.

